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Integrated Temperature Controllers for Peltier Modules

General Description

The MAX1978/MAX1979 are the smallest, safest, most accurate complete single-chip temperature controllers for Peltier thermoelectric cooler (TEC) modules. On-chip power FETs and thermal control-loop circuitry minimize external components while maintaining high efficiency. Selectable 500kHz/1MHz switching frequency and a unique ripple-cancellation scheme optimize component size and efficiency while reducing noise. Switching speeds of internal MOSFETs are optimized to reduce noise and EMI. An ultralow-drift chopper amplifier maintains ±0.001°C temperature stability. Output current, rather than voltage, is directly controlled to eliminate current surges. Individual heating and cooling current and voltage limits provide the highest level of TEC protection.

The MAX1978 operates from a single supply and provides bipolar ±3A output by biasing the TEC between the outputs of two synchronous buck regulators. True bipolar operation controls temperature without "dead zones" or other nonlinearities at low load currents. The control system does not hunt when the set point is very close to the natural operating point, where only a small amount of heating or cooling is needed. An analog control signal precisely sets the TEC current. The MAX1979 provides unipolar output up to 6A.

A chopper-stabilized instrumentation amplifier and a highprecision integrator amplifier are supplied to create a proportional-integral (PI) or proportional-integral-derivative (PID) controller. The instrumentation amplifier can interface to an external NTC or PTC thermistor, thermocouple, or semiconductor temperature sensor. Analog outputs are provided to monitor TEC temperature and current. In addition, separate overtemperature and undertemperature outputs indicate when the TEC temperature is out of range. An on-chip voltage reference provides bias for a thermistor bridge.

The MAX1978/MAX1979 are available in a low-profile 48-lead thin QFN-EP package and is specified over the -40°C to +85°C temperature range. The thermally enhanced QFN-EP package with exposed metal pad minimizes operating junction temperature. An evaluation kit is available to speed designs.

Applications

Fiber Optic Laser Modules WDM, DWDM Laser-Diode Temperature Control Fiber Optic Network Equipment EDFA Optical Amplifiers Telecom Fiber Interfaces ATE

Typical Operating Circuit appears at end of data sheet.

Features

- ♦ **Smallest, Safest, Most Accurate Complete Single-Chip Controller**
- ♦ **On-Chip Power MOSFETS—No External FETs**
- ♦ **Circuit Footprint < 0.93in2**
- ♦ **Circuit Height < 3mm**
- ♦ **Temperature Stability to 0.001°C**
- ♦ **Integrated Precision Integrator and Chopper Stabilized Op Amps**
- ♦ **Accurate, Independent Heating and Cooling Current Limits**
- ♦ **Eliminates Surges By Directly Controlling TEC Current**
- ♦ **Adjustable Differential TEC Voltage Limit**
- ♦ **Low-Ripple and Low-Noise Design**
- ♦ **TEC Current Monitor**
- ♦ **Temperature Monitor**
- ♦ **Over- and Undertemperature Alarm**
- ♦ **Bipolar ±3A Output Current (MAX1978)**
- ♦ **Unipolar +6A Output Current (MAX1979)**

Ordering Information

*EP = Exposed pad.

+Denotes a lead(Pb)-free/RoHS-compliant package.

Pin Configuration

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

Integrated Temperature Controllers for Peltier Modules

ABSOLUTE MAXIMUM RATINGS

Note 1: LX has internal clamp diodes to PGND and PVDD. Applications that forward bias these diodes should not exceed the IC's package power dissipation limits.

Note 2: Solder underside metal slug to PCB ground plane.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = V_{\overline{SHDN}} = 5V$, FREQ = GND, CTLI = FB+ = FB- = MAXV = MAXIP = MAXIN = REF, $T_A = 0^\circ C$ to +85°C, unless otherwise noted. Typical values at $T_A = +25^{\circ}C$.)

Integrated Temperature Controllers for Peltier Modules

ELECTRICAL CHARACTERISTICS (continued)

(VDD = PVDD1 = PVDD2 = VSHDN = 5V, FREQ = GND, CTLI = FB+ = FB- = MAXV = MAXIP = MAXIN = REF, **TA = 0°C to +85°C**, unless otherwise noted. Typical values at $T_A = +25^{\circ}C$.)

Integrated Temperature Controllers for Peltier Modules

ELECTRICAL CHARACTERISTICS (continued)

(VDD = PVDD1 = PVDD2 = VSHDN = 5V, FREQ = GND, CTLI = FB+ = FB- = MAXV = MAXIP = MAXIN = REF, **TA = 0°C to +85°C**, unless otherwise noted. Typical values at $T_A = +25^{\circ}C$.)

Integrated Temperature Controllers for Peltier Modules

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD}1 = PV_{DD}2 = V_{\overline{SHDN}} = 5V$, FREQ = GND, CTLI = FB+ = FB- = MAXV = MAXIP = MAXIN = REF, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.) (Note 5)

Integrated Temperature Controllers for Peltier Modules

ELECTRICAL CHARACTERISTICS (continued)

(VDD = PVDD1 = PVDD2 = VSHDN = 5V, FREQ = GND, CTLI = FB+ = FB- = MAXV = MAXIP = MAXIN = REF, **TA = -40°C to +85°C**, unless otherwise noted.) (Note 5)

Note 3: Includes power FET leakage. **Note 4:** CTLI gain is defined as:

$$
A_{\text{CTLI}} = \frac{(V_{\text{CTLI}} - V_{\text{REF}})}{(V_{\text{OSI}} - V_{\text{CS}})}
$$

Note 5: Specifications to -40°C are guaranteed by design, not production tested.

Integrated Temperature Controllers for Peltier Modules MAX1978/MAX1979

Typical Operating Characteristics

(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, RTEC = 1 Ω , circuit of Figure 1, T_A = +25°C, unless otherwise noted.)

Integrated Temperature Controllers for Peltier Modules MAX1978/MAX1979

Typical Operating Characteristics (continued)

(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, RTEC = 1 Ω , circuit of Figure 1, T_A = +25°C, unless otherwise noted.)

Integrated Temperature Controllers for Peltier Modules

Typical Operating Characteristics (continued)

(V_{DD} = 5V, V_{CTLI} = 1V, V_{FREQ} = GND, RTEC = 1 Ω , circuit of Figure 1, T_A = +25°C, unless otherwise noted.)

Pin Description

Integrated Temperature Controllers for Peltier Modules

Pin Description (continued)

Integrated Temperature Controllers for Peltier Modules

Functional Diagram

Integrated Temperature Controllers for Peltier Modules

Detailed Description

Power Stage

The power stage of the MAX1978/MAX1979 thermoelectric cooler (TEC) temperature controllers consists of two switching buck regulators that operate together to directly control TEC current. This configuration creates a differential voltage across the TEC, allowing bidirectional TEC current for controlled cooling and heating. Controlled cooling and heating allow accurate TEC temperature control within the tight tolerances of laser driver specifications.

The voltage at CTLI directly sets the TEC current. The internal thermal-control loop drives CTLI to regulate TEC temperature. The on-chip thermal-control circuitry can be configured to achieve temperature control stability of 0.001°C. Figure 1 shows a typical TEC thermalcontrol circuit.

Ripple Cancellation

Switching regulators like those used in the MAX1978/MAX1979 inherently create ripple voltage on each common-mode output. The regulators in the MAX1978 switch in phase and provide complementary in-phase duty cycles, so ripple waveforms at the differential TEC output are greatly reduced. This feature suppresses ripple currents and electrical noise at the TEC to prevent interference with the laser diode while minimizing output capacitor filter size.

Figure 1. MAX1978 Typical Application Circuit. Circuit is configured for both cooling and heating the NTC thermistor. Current flowing from OS2 and OS1 is cooling.

Integrated Temperature Controllers for Peltier Modules

Switching Frequency

FREQ sets the switching frequency of the internal oscillator. The oscillator frequency is 500kHz when $FREG =$ GND. The oscillator frequency is 1MHz when FREQ = V_{DD}. The 1MHz setting allows minimum inductor and filter-capacitor values. Efficiency is optimized with the 500kHz setting.

Voltage and Current-Limit Settings

The MAX1978 and MAX1979 provide settings to limit the maximum differential TEC voltage. Applying a voltage to MAXV limits the maximum voltage across the TEC to \pm (4 \times VMAXV).

The MAX1978 also limits the maximum positive and negative TEC current. The voltages applied to MAXIP and MAXIN independently set the maximum positive and negative output current limits. The MAX1979 controls TEC current in only one direction, so the maximum current is set only with MAXIP. MAXIN must be connected to MAXIP when using the MAX1979.

Chopper-Stabilized Instrumentation Amplifier

The MAX1978 and MAX1979 include a chopped input instrumentation amplifier with a fixed gain of 50. An external thermal sensor, typically a thermistor, is connected to one of the amp's inputs. The other input is connected to a voltage that represents the temperature set point. This set point can be derived from a resistordivider network or DAC. The included instrumentation amplifier provides low offset drift needed to prevent temperature set-point drift with ambient temperature changes. Temperature stability of 0.001°C can be achieved over a 0°C to +50°C ambient temperarure range by using the amplifier as in Figure 1. DIFOUT is the instrumentation amplifier output and is proportional to 50 times the difference between the set-point temperature and the TEC temperature. This difference is commonly referred to as the "error signal". For best temperature stability, derive the set-point voltage from the same reference that drives the thermistor (usually the MAX1978/MAX1979 REF output). This is called a "ratiometric" or "bridge" connection. The bridge connection optimizes stability by eliminating REF drift as an error source. Errors at REF are nullified because they affect the thermistor and set point equally.

The instrumentation amplifier utilizes a chopped input scheme to minimize input offset voltage and drift. This generates output ripple at DIFOUT that is equal to the chop frequency. The DIFOUT peak-to-peak ripple amplitude is typically 100mV but has no effect on temperature stability. DIFOUT ripple is filtered by the integrator in the following stage. The chopper frequency is derived from, and is synchronized to, the switching frequency of the power stage.

Integrator Amplifier

An on-chip integrator amplifier is provided on the MAX1978/MAX1979. The noninverting terminal of the amplifier is connected internally to REF. Connect an appropriate network of resistors and capacitors between DIFOUT and INT-, and connect INTOUT to CTLI for typical operation. CTLI directly controls the TEC current magnitude and polarity. The thermal-control-loop dynamics are set by the integrator input and feedback components. See the Applications Information section for details on thermal-loop compensation.

Current Monitor Output

ITEC provides a voltage output proportional to the TEC current, ITEC (see the Functional Diagram):

$$
V_{\text{ITEC}} = 1.5V + 8 \times (V_{\text{OS1}} - V_{\text{CS}})
$$

Over- and Under-Temperature Alarms

The MAX1978/MAX1979 provide open-drain status outputs that alert a microcontroller when the TEC temperature is over or under the set-point temperature. \overline{OT} and \overline{UT} pull low when $V_{(FB1+ - FB-)}$ is more than 20mV. For a typical thermistor connection, this translates to approximately 1.5°C error.

Reference Output

The MAX1978/MAX1979 include an on-chip 1.5V voltage reference accurate to 1% over temperature. Bypass REF with 1µF to GND. REF can be used to bias an external thermistor for temperature sensing as shown in Figures 1 and 2. Note that the 1% accuracy of REF does not limit the temperature stability achievable with the MAX1978/MAX1979. This is because the thermistor and set-point bridge legs are intended to be driven ratiometrically by the same reference source (REF). Variations in the bridge-drive voltage then cancel out and do not generate errors. Consequently, 0.001°C stable temperature control is achievable with the MAX1978/MAX1979 reference.

An external source can be used to bias the thermistor bridge. For best accuracy, the common-mode voltage applied to FB+ and FB- should be kept between 0.5V and 1V, however the input range can be extended from 0.2V to V_{DD} / 2 if some shift in instrumentation amp offset (approximately -50µV/V) can be tolerated. This shift remains constant with temperature and does not contribute to set-point drift.

Integrated Temperature Controllers for Peltier Modules

Figure 2. MAX1979 Typical Application Circuit. MAXIN sets the maximum TEC current circuit configured for cooling with NTC thermistor. Current always flow from CS and OS2.

Buffered Outputs, BFB+ and BFB-

BFB+ and BFB- output a buffered version of the voltage that appears on FB+ and FB-, respectively. The buffers are typically used in conjunction with the undedicated chopper amplifier to create a monitor for the thermistor voltage/TEC temperature (Figures 1 and 2). These buffers are unity-gain chopper amplifiers and exhibit output ripple. Each output can be either integrated or filtered to remove the ripple content if necessary.

Undedicated Chopper-Stabilized Amplifier

In addition to the chopper amplifiers at DIFOUT and BFB_, the MAX1978/MAX1979 include an additional chopper amplifier at AOUT. This amplifier is uncommitted but is intended to provide a temperature-proportional analog output. The thermistor voltage typically is connected to the undedicated chopper amplifier through the included buffers BFB+ and BFB-. Figure 3 shows how to configure the undedicated amplifier as a thermistor voltage monitor. The output voltage at AOUT is not precisely linear, because the thermistor is not linear. AOUT is also chopper stabilized and exhibits output ripple and can be either integrated or filtered to remove the ripple content if necessary.

Figure 3. Thermistor Voltage Monitor

Desian Procedure

Inductor Selection

Small surface-mount inductors are ideal for use with the MAX1978/MAX1979. Select the output inductors so that the LC resonant frequency of the inductance and the output capacitance is less than 1/5 the selected switching frequency. For example, 3.0µH and 1µF have a resonance at 92kHz, which is adequate for 500kHz operation.

na dia kaominina dia 49.0000° ary 2.0000° amin'ny soratra desimaly.
Ny faritr'ora dia GMT+1.

$$
f_{LC} = \frac{1}{2\pi\sqrt{LC}}
$$

where:

 f_L = resonant frequency of output filter.

Capacitor Selection

Filter Capacitors

Decouple each power-supply input (V_{DD}, PV_{DD}1, and PV_{DD}2) with a 10µF ceramic capacitor close to the supply pins. If long supply lines separate the source supply from the MAX1978/MAX1979, or if the source supply has high output impedance, place an additional 22µF to 100µF ceramic capacitor between the V_{DD} power plane and power ground. Insufficient supply bypassing can result in supply bounce and degraded accuracy.

Compensation Capacitor

Include a compensation capacitor to ensure currentpower control-loop stability. Select the capacitor so that the unity-gain bandwidth of the current-control loop is less than or equal to 10% the resonant frequency of the output filter:

$$
C_{\text{COMP}} \geq \left(\frac{g_m}{f_{BW}}\right) \times \left(\frac{24 \times R_{\text{SENSE}}}{2\pi \times (R_{\text{SENSE}} + R_{\text{TEC}})}\right)
$$

where:

 f BW = unity-gain bandwidth frequency

 g_m = loop transconductance, typically 100 μ A/V

CCOMP = value of the compensation capacitor

RTEC = TEC series resistance

RSENSE = sense resistor

Setting Voltage and Current Limits

Consider TEC parameters to guarantee a robust design. These parameters include maximum positive current, maximum negative current, and the maximum voltage allowed across the TEC. These limits should be used to set MAXIP, MAXIN, and MAXV voltages.

Setting Max Positive and Negative TEC Current MAXIP and MAXIN set the maximum positive and negative TEC currents, respectively. The default current limit is ±150mV / RSENSE when MAXIP and MAXIN are connected to REF. To set maximum limits other than the defaults, connect a resistor-divider from REF to GND to set VMAXI. Use resistors in the 10kΩ to 100kΩ range. V_{MAXI} is related to ITEC by the following equations:

> $V_{MAXIP} = 10 (I_{TECP(MAX)} \times R_{SENSE})$ $V_{MAXIN} = 10 (IFECN(MAX) \times RSENSE)$

where ITECP(MAX) is the maximum positive TEC current and ITECN(MAX) is the maximum negative TEC current. Positive TEC current occurs when CS is less than OS1:

> ITEC \times RSENSE = CS - OS1 when ITEC $<$ 0. ITEC \times RSENSE = OS1 - CS when ITEC > 0 .

Integrated Temperature Controllers for Peltier Modules

The MAX1979 controls the TEC current in only one direction (unipolar). Set the maximum unipolar TEC current by applying a voltage to MAXIP. Connect MAXIN to MAXIP when using the MAX1979. The equation for setting MAXIP is the same for the MAX1978 and MAX1979. Do not exceed the positive or negative current-limit specifications on the TEC. Refer to the TEC manufacturer's data sheet for these limits.

Setting Max TEC Voltage

Apply a voltage to MAXV to control the maximum differential TEC voltage. MAXV can vary from 0 to REF. The voltage across the TEC is four times V_{MAXV} and can be positive or negative.

 $|V$ OS1 - V OS2 $| = 4 \times V$ MAXV

Use resistors from 10k Ω to 100k Ω to form a voltagedivider to set VMAXV.

Thermal-Control Loop

The MAX1978/MAX1979 provide all the necessary amplifiers needed to create a thermal-control loop. Typically, the chopper-stabilized instrumentation amplifier generates an error signal and the integrator amplifier is used to create a PID controller. Figure 4 shows an example of a simple PID implementation. The error signal needed to control the loop is generated from the difference between the set point and the thermistor voltage. The desired set-point voltage can be derived from a potentiometer, DAC, or other voltage source. Figure 5 details the required connections. Connect the output of the PID controller to CTLI. For details, see the Applications Information section.

Figure 4. Proportional Integral Derivative Controller

Figure 5. The Set Point can be Derived from a Potentiometer or a DAC

Control Inputs/Outputs

TEC Current Control

The voltage at CTLI directly sets the TEC current. CTLI typically is driven from the output of a temperature-control circuit CINTOUT. For the purposes of the following equations, it is assumed that positive TEC current is heating.

The transfer function relating current through the TEC (ITEC) and VCTLI is given by:

$$
ITEC = (VCTLI - VREF) / (10 \times RSENSE)
$$

where VREF is 1.50V

and $I_{TEC} = (V_{OS1} - V_{CS}) / R_{SENSE}$

 V_{CTI} is centered around REF (1.50V). ITEC is zero when $V_{\text{CTI}} = 1.50V$. When $V_{\text{CTI}} > 1.50V$, the MAX1978 is heating. Current flow is from OS2 to OS1. The voltages are:

$$
V_{OS2} > V_{OS1} > V_{CS}
$$

when V_{CTL} < 1.50V, current flows from OS1 to OS2: V OS2 < V OS1 < V CS

Integrated Temperature Controllers for Peltier Modules MAX1978/MAX1979

Shutdown Control

Drive SHDN low to place the MAX1978/MAX1979 in a power-saving shutdown mode. When the MAX1978/ MAX1979 are in shutdown, the TEC is off (V _{OS1} and V_{OS2} decay to GND) and input supply current lowers to 2mA (typ).

ITEC Output

ITEC is a status output that provides a voltage proportional to the actual TEC current. ITEC = REF when TEC current is zero. The transfer function for the ITEC output:

$$
V
$$
ITEC = 1.50 + 8 × (V_{OS1} - V_{CS})

Use ITEC to monitor the cooling or heating current through the TEC. The maximum capacitance that ITEC can drive is 100pF.

Applications Information

The MAX1978/MAX1979 drive a thermoelectric cooler inside a thermal-control loop. TEC drive polarity and power are regulated to maintain a stable control temperature based on temperature information read from a thermistor, or from other temperature-measuring devices. Carefully selected external components can achieve 0.001°C temperature stability. The MAX1978/ MAX1979 provide precision amplifiers and an integrator amplifier to implement the thermal-control loop (Figures 1 and 2).

Connecting and Compensating the Thermal-Control Loop

Typically, the thermal loop consists of an error amplifier and proportional integral derivative controller (PID) (Figure 4). The thermal response of the TEC module must be understood before compensating the thermal loop. In particular, TECs generally have stronger heating capacity than cooling capacity because of the effects of waste heat. Consider this point when analyzing the TEC response.

Analysis of the TEC using a signal analyzer can ease compensation calculations. Most TECs can be crudely modeled as a two-pole system. The second pole potentially creates an oscillatory condition because of the associated 180° phase shift. A dominant pole compensation scheme is not practical because the crossover frequency (the point of the Bode plot where the gain is zero dB) must be below the TEC's first pole, often as low as 0.02Hz. This requires an excessively large integrator capacitor and results in slow loop-transient response. A better approach is to use a PID controller, where two additional zeros are used to cancel the TEC and integrator poles. Adequate phase margin can be achieved near the frequency of the TEC's second pole when using a PID controller. The following is an example of the compensation procedure using a PID controller.

Figure 6 details a two-pole transfer function of a typical TEC module. This Bode plot can be generated with a signal analyzer driving the CTLI input of the MAX1978/MAX1979, while plotting the thermistor voltage from the module. For the example module, the two poles are at 0.02Hz and 1Hz.

The first step in compensating the control loop involves selecting components R3 and C2 for highest DC gain. Film capacitors provide the lowest leakage but can be large. Ceramic capacitors are a good compromise between low leakage and small size. Tantalum and electrolytic capacitors have the highest leakage and generally are not suitable for this application. The integrating capacitor, C2, and R3 (Figure 4) set the first zero (fz1). The specific application dictates where the first zero should be set. Choosing a very low frequency results in a very large value capacitor. Set the first zero frequency to no more than 8 times the frequency of the lowest TEC pole. Setting the frequency more than 8 times the lowest pole results in the phase falling below -135° and may cause instability in the system. For this example, C2 = 10µF. Resistor R3 then sets the zero at 0.16Hz using the following equation:

$$
fz1 = \frac{1}{2\pi \times C2 \times R3}
$$

This yields a value of R3 = $99.47k\Omega$. For our example, use 100kΩ.

Next, adjust the gain for a crossover frequency for maximum phase margin near the TEC's second pole. From Figure 6, the TEC bode plot, approximately 30dB of gain is needed to move the 0dB crossover point up to 1.5Hz. The error amplifier provides a fixed gain of 50, or approximately 34dB. Therefore, the integrator needs to provide -4dB of gain at 1.5Hz. C1 and R3 set the gain at the crossover frequency.

$$
C1 = \frac{A}{\frac{1}{C2} + 2\pi \times R3 \times t_C}
$$

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where:

 $A =$ The gain needed to move the OdB crossover point up to the desired frequency. In this case, $A = -4dB =$ 0.6.

 f_C = The desired crossover frequency, 1.5Hz in this example.

C1 is found to be 0.58µF; use 0.47µF.

Next, the second TEC pole must be cancelled by adding a zero. Canceling the second TEC pole provides maximum phase margin by adding positive phase to the circuit. Setting a second zero (fz2) to at least $1/5$ the crossover frequency (1.5Hz/5 = 0.3Hz), and a pole (fp1) to 5 times the crossover frequency or higher (5×1.5 Hz = 7.5Hz) ensures good phase margin, while allowing for variation in the location of the TEC's second pole. Set the zero fz2 to 0.3Hz and calculate R2:

$$
fzz = \frac{1}{2\pi \times C1 \times R2}
$$

where fz2 is the second zero.

R2 is calculated to be 1.1MΩ; use 1MΩ.

Now pole fp1 is added at least 5 times the crossover frequency to terminate zero fz2.

Figure 6. Bode Plot of a Generic TEC Module

Choose fp1 = $15Hz$, find R1 using the following equation:

$$
fp1 = \frac{1}{2\pi \times C1 \times R1}
$$

Resistor R1 is found to be 22k Ω , use 20k Ω

The final step is to terminate the first zero by setting the rolloff frequency with a second pole, fp2. A good choice is 2 times fp1.

Choose fp2 = 30Hz, find C3 using the following equation:

$$
fp2 = \frac{1}{2\pi \times C3 \times R3}
$$

where C3 is found to be 0.05µF, use 0.047µF.

Figure 7 displays the compensated gain and phase plots for the above example.

The example given is a good place to start when compensating the thermal loop. Different TEC modules require individual testing to find their optimal compensation scheme. Other compensation schemes can be used. The above procedure should provide good results for the majority of optical modules.

Figure 7. Compensated Thermal-Control Loop Using the TEC Module in Figure 6

Integrated Temperature Controllers for Peltier Modules

Typical Operating Circuit

Chip Information

TRANSISTOR COUNT: 6023 PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Integrated Temperature Controller for Peltier Modules

Revision History

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

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